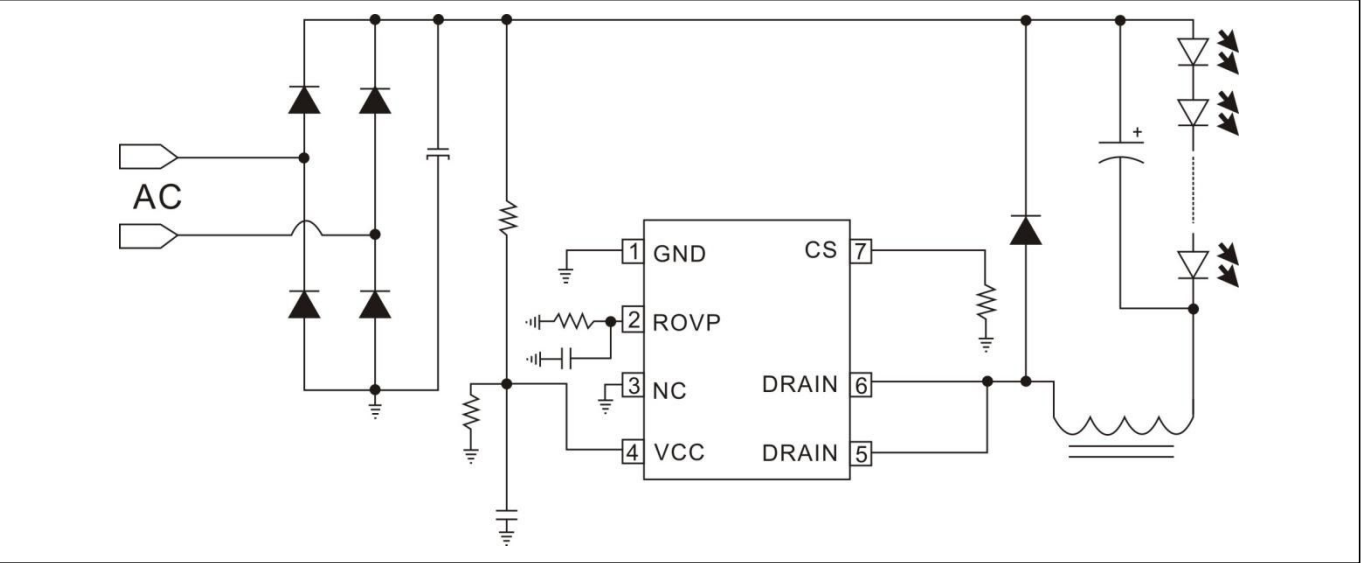




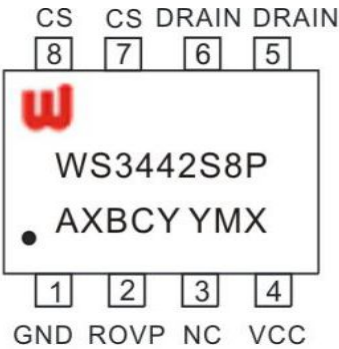
Typical Application(DIP-7 Package)



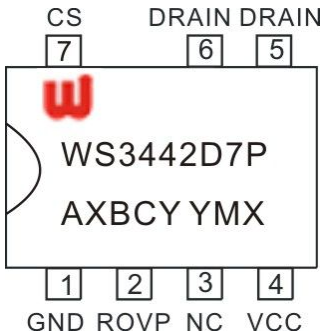
Attention: A 22pF capacitor can be parallel with Rovp and a resistor can be parallel with the Vcc capacitor.

Pin Configuration and Marking Information

The WS3442 is available in SOP-8 Package and DIP-7 Package,the top marking is shown as below:



WS3442S8P  
A: Product Code  
X: Internal Code  
BCY: Internal Code For QC  
YMX: D/C

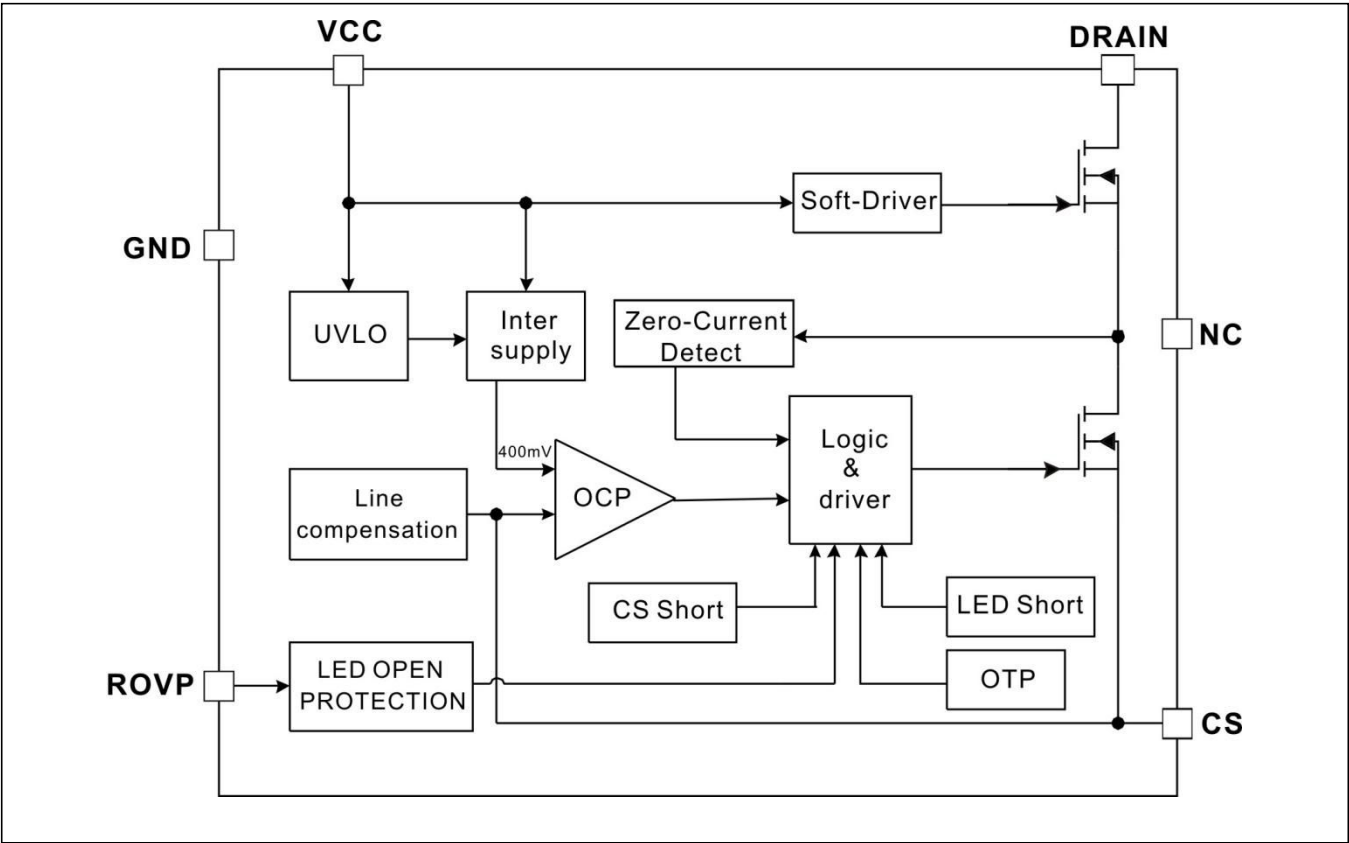


WS3442D7P  
A: Product Code  
X: Internal Code  
BCY: Internal Code For QC  
YMX: D/C

Pin Definition

| Name  | Pin No. | Description                                                               |
|-------|---------|---------------------------------------------------------------------------|
| GND   | 1       | Ground                                                                    |
| ROVP  | 2       | Over Voltage Protection Setting Pin. Connect a resistor to GND            |
| NC    | 3       | No Connection. Should be connected to GND(Pin1)                           |
| VCC   | 4       | Power Supply Pin                                                          |
| DRAIN | 5/6     | Internal HV Power MOSFET Drain.                                           |
| CS    | 7/8     | Current Sense Pin. Connect a sense resistor between this pin and GND pin. |

Internal Block Diagram



Ordering Information

| Package              | Marking   | Part Number |
|----------------------|-----------|-------------|
| 8-Pin SOP-8, Pb-free | WS3442S8P | WS3442S8P   |
| 7-Pin DIP-7, Pb-free | WS3442D7P | WS3442D7P   |

Recommended Operation Conditions

| Part Number | Package | Input voltage | Maximum output power     |
|-------------|---------|---------------|--------------------------|
| WS3442S8P   | SOP8    | 175VAC-264VAC | 80V/280mA<br>120V/220mA  |
|             |         | 90VAC-264VAC  | 80V/220mA<br>60V/300mA   |
| WS3442D7P   | DIP7    | 175VAC-264VAC | 120V/280mA<br>160V/220mA |
|             |         | 90VAC-264VAC  | 80V/300mA                |

**Absolute Maximum Ratings**

| symbol        | paramete                          | Range    | unit |
|---------------|-----------------------------------|----------|------|
| $V_{DS}$      | Internal HV MOSFET drain voltage  | -0.3~500 | V    |
| $I_{CC\_MAX}$ | VCC pin maximum sink current      | 2.5      | mA   |
| $V_{ROVP}$    | Over-voltage setting pin voltage  | -0.3~7   | V    |
| $V_{SOURCE}$  | Internal HV MOSFET source voltage | -0.3~8   | V    |
| $V_{CS}$      | Current sense pin input voltage   | -0.3~7   | V    |
| $P_{D\_MAX}$  | Power dissipation SOP8            | 0.6      | W    |
| $P_{D\_MAX}$  | Power dissipation DIP7            | 0.9      | W    |
| $T_J$         | Operating junction temperature    | 165      | °C   |
| $T_{STG}$     | Storage temperature range         | -55~165  | °C   |

**Note :** Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device.

**Electrical Characteristics** (Unless otherwise specified, VCC=7V and TA =25 °C)

| Symbol                               | Parameter                                    | Conditions                                | Min | Typ | Max | Units |
|--------------------------------------|----------------------------------------------|-------------------------------------------|-----|-----|-----|-------|
| <b>Supply Voltage Section</b>        |                                              |                                           |     |     |     |       |
| V <sub>CC_CLAMP</sub>                | VCC Clamp Voltage                            | I <sub>VCC</sub> =1mA                     |     | 7.3 |     | V     |
| I <sub>CC_CLAMP</sub>                | VCC Clamp current                            |                                           |     |     | 2.5 | mA    |
| V <sub>CC_ST</sub>                   | VCC Turn On Threshold                        | VCC Rising                                |     | 6.9 |     | V     |
| V <sub>UVLO_HYS</sub>                | VCC Turn off Hysteresis                      | VCC Falling                               |     | 1.5 |     | V     |
| I <sub>ST</sub>                      | VCC Startup Current                          | VCC<VCC_ST-0.5V                           |     | 230 | 270 | uA    |
| I <sub>OP</sub>                      | VCC Operating Current                        |                                           |     | 200 |     | uA    |
| <b>Current Sense Section</b>         |                                              |                                           |     |     |     |       |
| V <sub>CS_TH</sub>                   | Threshold Voltage for Peak Current Limit     |                                           | 390 | 400 | 410 | mV    |
| T <sub>LEB</sub>                     | Leading Edge Blanking Time for Current Sense |                                           |     | 350 |     | ns    |
| T <sub>DELAY</sub>                   | Switch Off Delay Time                        |                                           |     | 300 |     | ns    |
| <b>Internal Time Control Section</b> |                                              |                                           |     |     |     |       |
| T <sub>OFF_MIN</sub>                 | Minimum OFF Time                             |                                           |     | 3   |     | us    |
| T <sub>OFF_MAX</sub>                 | Maximum OFF Time                             |                                           |     | 340 |     | us    |
| T <sub>ON_MAX</sub>                  | Maximum On Time                              |                                           |     | 53  |     | us    |
| <b>MOSFET Section</b>                |                                              |                                           |     |     |     |       |
| R <sub>DS(on)</sub>                  | Static Drain-source On-resistance            | V <sub>CC</sub> =7V/I <sub>D</sub> =0.5A  |     | 4.8 | 6   | ohm   |
| V <sub>DS_BD</sub>                   | Drain-Source Breakdown Voltage               | V <sub>GS</sub> =0V/I <sub>D</sub> =250uA | 500 |     |     | V     |
| I <sub>DSS</sub>                     | Power MOSFET Drain Leakage Current           | V <sub>GS</sub> =0V/V <sub>DS</sub> =500V |     |     | 10  | uA    |
| <b>ROVP section</b>                  |                                              |                                           |     |     |     |       |
| V <sub>ROVP</sub>                    | ROVP Pin Voltage                             |                                           |     | 0.5 |     | V     |
| <b>Thermal Regulation Section</b>    |                                              |                                           |     |     |     |       |
| T <sub>SD</sub>                      | Thermal Shutdown Temperature                 |                                           |     | 160 |     | °C    |
| T <sub>SD_HYS</sub>                  | Thermal Shutdown Hysteresis                  |                                           |     | 20  |     | °C    |
| T <sub>COMP</sub>                    | Thermal Regulation Temperature               |                                           |     | 150 |     | °C    |

## Application Information

The WS3442 is a high performance non-isolated Buck converter specially designed for LED lighting. The device integrates a 500V power MOSFET. With very few external components, the converter achieves excellent constant current control. And it does not need auxiliary winding for powering the IC or voltage sensing, hence the system size and cost is greatly reduced.

### Start Up

After system powered up, the VCC pin capacitor is charged up by the start up resistor. When the VCC pin voltage reaches the turn on threshold, the internal circuits start operating. The WS3442 integrates a 17V zener diode to clamp the VCC voltage. Due to the ultra-low operating current, the auxiliary winding is not needed to supply the IC.

The maximum value of the startup current is 270uA. For the application of 176VAC — 264VAC, the startup resistor can be calculated by the equation:

$$R_{st} < \frac{V_{in\_min} \times 1.414}{I_{st\_max}} \approx \frac{176V \times 1.414}{270\mu A} = 920k\Omega$$

### Constant Current Control

Cycle by Cycle current sense is adopted in WS3442, the CS pin is connected to the current sense comparator, and the voltage on CS pin is compared with the internal 400mV reference voltage. The MOSFET will be switched off when the voltage on CS pin reaches the threshold. The CS comparator includes a 350ns leading edge blanking time.

The peak inductor current is given by:

$$I_{PK} = \frac{400}{R_{CS}} (\text{mA})$$

Where, RCS is the current sense resistor value.

The current in LED can be calculated by the equation:

$$I_{LED} = \frac{I_{PK}}{2}$$

Where, IPK is the peak current of the inductor.

### Inductor Selection

The WS3442 works under inductor current critical conduction mode. When the power MOSFET is switched on, the current in the inductor rises up from zero, the on time of the MOSFET can be calculated by the equation:

$$t_{on} = \frac{L \times I_{PK}}{V_{IN} - V_{LED}}$$

Where,

L is the inductance value

VIN is the DC bus voltage after the rectifier bridge

VLED is the voltage on the LED

After the power MOSFET is switched off, the current in the inductor decreases. When the inductor current reaches zero, the power MOSFET is turned on again by IC internal logic. The off time of the MOSFET is given by:

$$t_{off} = \frac{L \times I_{PK}}{V_{LED}}$$

The inductance can be calculated by the equation:

$$L = \frac{V_{LED} \times (V_{IN} - V_{LED})}{f \times I_{PK} \times V_{IN}}$$

The f is the system switching frequency, which is proportional to the input voltage. So the minimum switching frequency is set at lowest input voltage, and the maximum switching frequency is set at highest input voltage.

The minimum and maximum off time of WS3442 is set at 3us and 340us, respectively. Referring to the equation of Toff calculation, if the inductance is too small, the Toff may be smaller than the minimum off time, system will operate in discontinuous conduction mode and the output current will be smaller than the designed value. If the inductance is too large, the Toff may be larger than the maximum off time, the system will operate in continuous conduction mode and the output current will be higher than the designed value. So it is important to choose a proper inductance.

### Over Voltage Protection

The over voltage protection can be programmed by the ROVP pin resistor. The ROVP pin voltage is 0.5V.

When the LED is open circuit, the output voltage increases gradually, and the demagnetization time gets shorter. The demagnetization time at OVP---- Tovp can be calculated by the open circuit protection voltage:

$$Tovp \approx \frac{L \times V_{cs}}{R_{cs} \times V_{ovp}}$$

Where,

Vcs is the CS pin turn off threshold (400mV)

Vovp is the open circuit protection voltage

And then the Rovp resistor value can be calculated by the equation:

$$Rovp \approx 3.3 * T_{ovp} * 10^6 \quad (\text{kohm})$$

### Protection Function

The WS3442 offers rich protection functions to improve the system reliability, including LED open/short protection, CS resistor short protection, VCC under voltage protection, thermal regulation. When the LED is open circuit, the system will trigger the over voltage protection and stop switching.

When the LED short circuit is detected, the system works at low frequency (5kHz), and the CS pin turn off threshold is reduced to 200mV. So the system power consumption is very low. At some catastrophic fault condition, such as CS resistor shorted or inductor saturated, the internal fast fault detection circuit will be triggered, the system stops switching immediately.

After the system enters into fault condition, the VCC voltage will decrease until it reaches the UVLO threshold, then the system will re-start again. If the fault condition is removed, the system will recover to normal operation.

### Thermal Regulation

The WS3442 integrates thermal regulation function. When the system is over temperature, the output current is gradually reduced; the output power and thermal dissipation are also reduced. The system temperature is regulated and the system reliability is improved. The thermal regulation temperature is set to 150°C internally.

### PCB Layouts

The following rules should be followed in WS3442 PCB layout:

#### Vcc Capacitor

The bypass capacitor on VCC pin should be as close as possible to the VCC Pin and GND pin.

#### ROVP Pin

The ROVP resistor should be as close as possible to the ROVP Pin.

#### Ground Path

The power ground path for current sense should be short, and the power ground path should be separated from small signal ground path before connecting to the negative node of the bulk capacitor.

#### The Area of Power Loop

The area of main current loop should be as small as possible to reduce EMI radiation, such as the inductor, the power MOSFET, the output diode and the bus capacitor loop.

#### NC pin

The NC pin should be connected to GND (pin1).

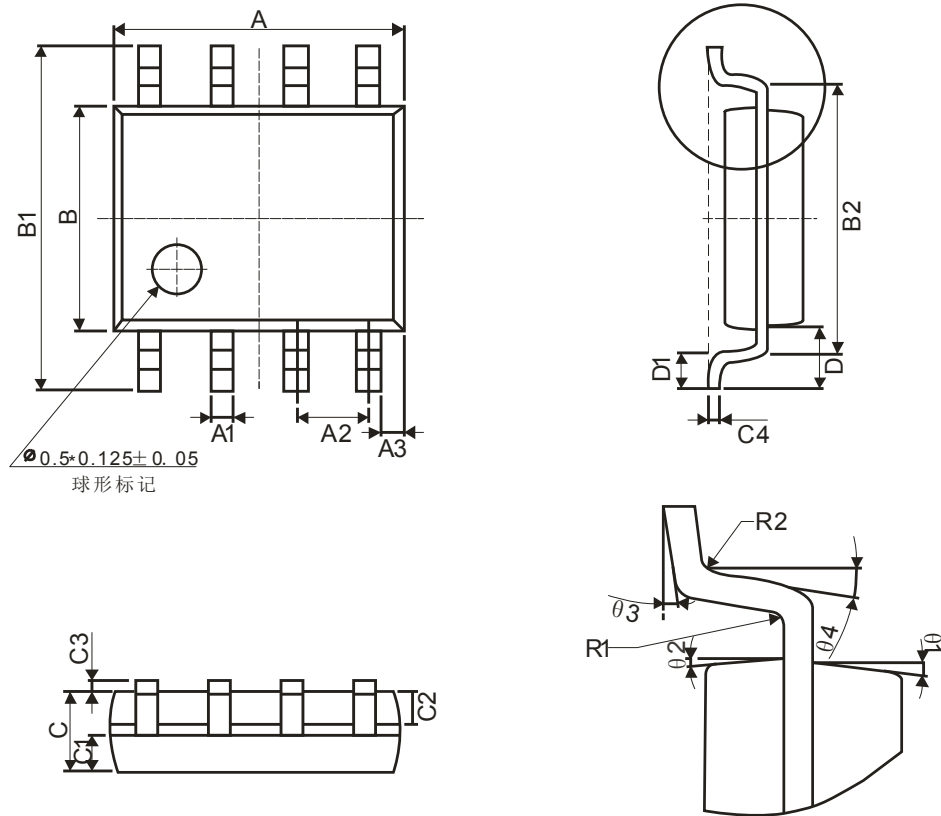
#### Drain Pin

To increase the copper area of DRAIN pin for better thermal dissipation. However too large copper area may compromise EMI performance.

#### The material of PCB

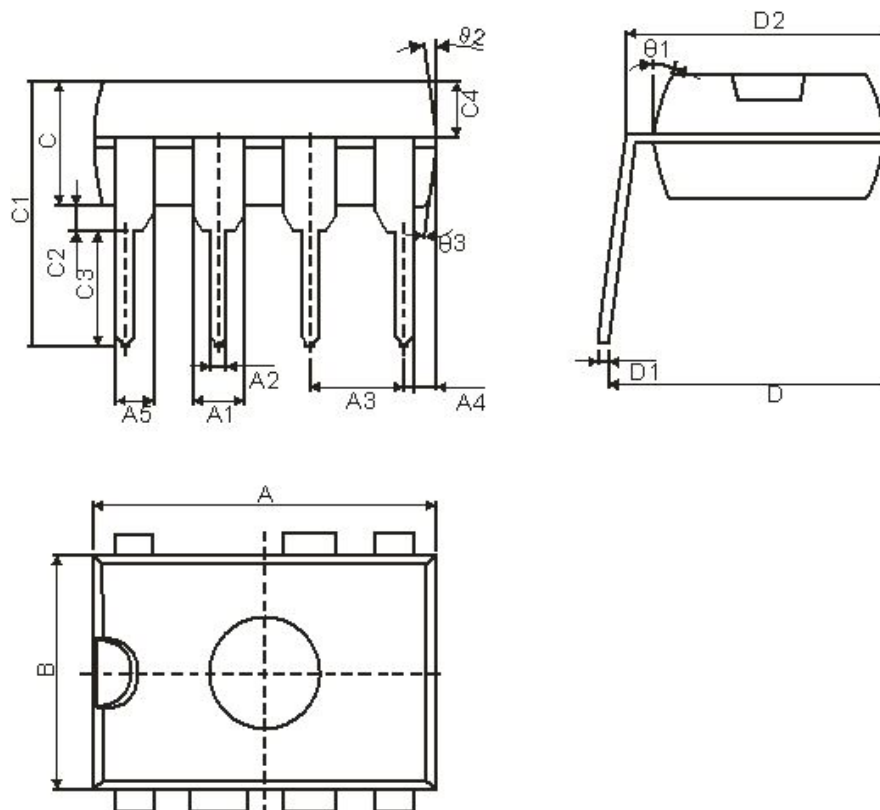
Avoid choosing the material that is easy to absorb the moisture, just like paper copper-clad laminates.

Package Information  
SOP8 Package Outline Dimensions



| Symbol | Winsemi                   |       |                      |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Dimensions in Millimeters |       | Dimensions in Inches |       |
|        | Min                       | Max   | Min                  | Max   |
| A      | 4.70                      | 5.10  | 0.185                | 0.201 |
| B      | 3.70                      | 4.10  | 0.146                | 0.161 |
| C      | 1.30                      | 1.50  | 0.051                | 0.059 |
| A1     | 0.35                      | 0.48  | 0.014                | 0.019 |
| A2     | 1.27TYP                   |       | 0.05TYP              |       |
| A3     | 0.345TYP                  |       | 0.014TYP             |       |
| B1     | 5.80                      | 6.20  | 0.228                | 0.244 |
| B2     | 5.00TYP                   |       | 0.197TYP             |       |
| C1     | 0.55                      | 0.70  | 0.022                | 0.028 |
| C2     | 0.55                      | 0.70  | 0.022                | 0.028 |
| C3     | 0.05                      | 0.225 | 0.002                | 0.009 |
| C4     | 0.203TYP                  |       | 0.008TYP             |       |
| D      | 1.05TYP                   |       | 0.041TYP             |       |
| D1     | 0.40                      | 0.80  | 0.016                | 0.031 |

## DIP7 Package Outline Dimensions



| Winsemi |                           |       |                      |       |
|---------|---------------------------|-------|----------------------|-------|
| Symbol  | Dimensions in Millimeters |       | Dimensions in Inches |       |
|         | Min                       | Max   | Min                  | Max   |
| A       | 9.00                      | 9.50  | 0.354                | 0.374 |
| B       | 6.10                      | 6.60  | 0.240                | 0.260 |
| C       | 3.0                       | 3.4   | 0.118                | 0.134 |
| A1      | 1.474                     | 1.574 | 0.058                | 0.062 |
| A2      | 0.41                      | 0.53  | 0.016                | 0.021 |
| A3      | 2.44                      | 2.64  | 0.096                | 0.104 |
| A4      | 0.51TYP                   |       | 0.02TYP              |       |
| A5      | 0.99TYP                   |       | 0.04TYP              |       |
| C1      | 6.6                       | 7.30  | 0.260                | 0.287 |
| C2      | 0.50TYP                   |       | 0.02TYP              |       |
| C3      | 3.00                      | 3.40  | 0.118                | 0.134 |
| C4      | 1.47                      | 1.65  | 0.058                | 0.065 |
| D       | 7.62                      | 9.3   | 0.300                | 0.366 |
| D1      | 0.24                      | 0.32  | 0.009                | 0.013 |
| D2      | 7.62TYP                   |       | 0.3TYP               |       |

**NOTE:**

- 1.We strongly recommend customers check carefully on the trademark when buying our product, if there is any question, please don't be hesitate to contact us.
- 2.Please do not exceed the absolute maximum ratings of the device when circuit designing.
- 3.Winsemi Microelectronics Co., Ltd reserved the right to make changes in this specification sheet and is subject to change without prior notice.

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